CMOS LSI

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LC7871E, 7871NE

CD Graphics Decoder

Overview

The LC7871E and LC7871NE are CMOS LSIs that integrate the signal processing functions required for compact disk extended graphics (CD-EG) decoding in a single chip. These products accept the R to W subcode signals output by CDP-DSP products such as the LC7860KA, LC7867E, LC7868E, LC7869E, or LC78681E, and perform de-interleaving, error detection and correction, graphics instruction processing, and image processing.

Functions

- The LC7871E and LC7871NE allow a CD-EG decoder to be constructed with only three chips with the addition of two external DRAMs (64k × 4). (An RGB encoder is provided on chip.)
- The LC7871E and LC7871NE perform subcode synchronization signal interpolation and protection. They also perform R to W signal de-interleaving and error detection and correction.
- These products include two crystal oscillator systems (one for NTSC and one for PAL) which can be easily switched from a control pin. These products generate the reference clocks as well as all internal timings for these two standards by using a 14.31818 MHz crystal for NTSC and a 17.734476 MHz crystal for PAL.
- Control of image display using CD graphics instructions and display processing.
- Composite video 8-bit D/A converter output as well as "define-transparency" 6-bit D/A converter output.
- Support for superimposition
- Microprocessor interface function that supports end-product upgrades.
- External input pin for channel selection
- Built-in 6-bit RGB D/A converters
- The only difference between the LC7871E and the LC7871NE is in the BGC to VRAM transfer. The LC7871E uses a preset memory instruction for transfer to VRAM, whereas the LC7871NE uses the load CLUT instruction.
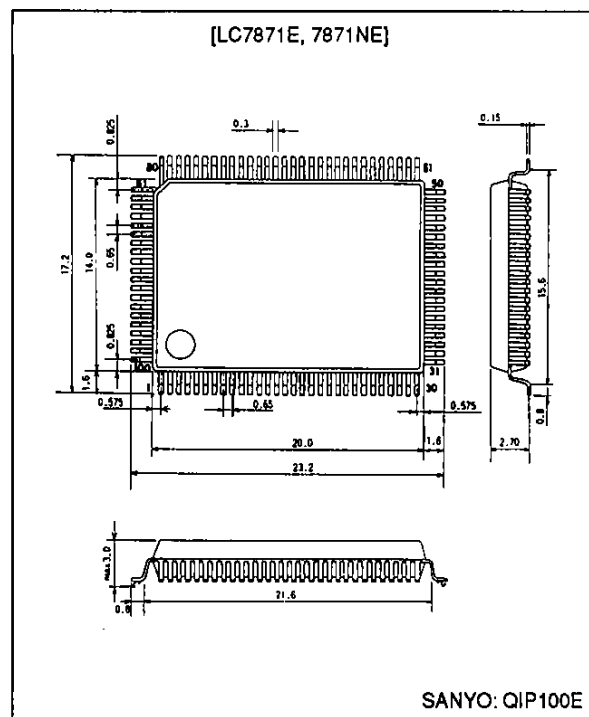
Features

- A CD-G decoder can be constructed from only two chips, since no controller is required.
- A CD-EG decoder can be constructed with the addition of two 256-kbit DRAMs since no controller is required.
- Silicon gate CMOS process for low power dissipation
- 5 V single voltage power supply

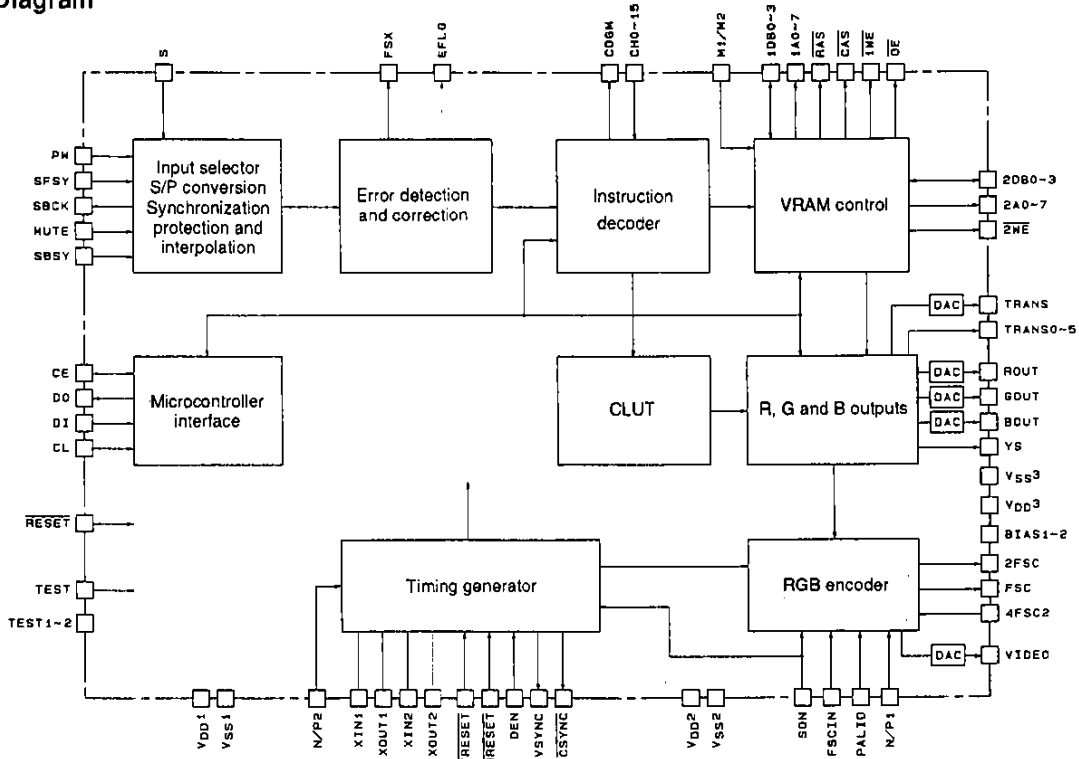## Package Dimensions

unit: mm

3151-QIP100E

[LC7871E, 7871NE]

SANYO: QIP100E

SANYO Electric Co., Ltd. Semiconductor Business Headquarters

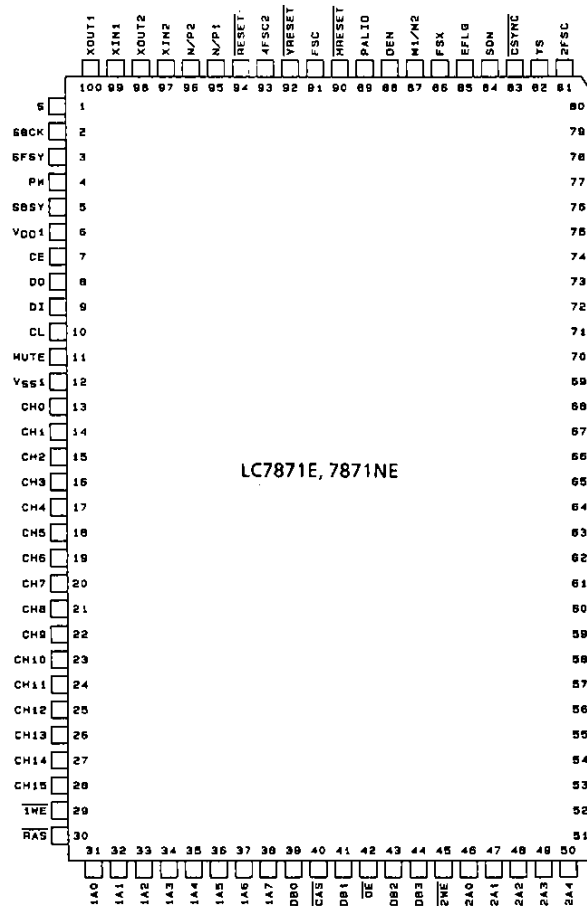TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110 JAPAN

Block Diagram

Pin Assignment

Top View

Specifications

Absolute Maximum Ratings at Ta = 25°C, V_{SS} = 0 V

Parameter	Symbol	Ratings	Unit
Maximum supply voltage	V_{DD} max	V_{SS} – 0.3 to +7.0	V
Maximum input voltage	V_{IN} max	V_{SS} – 0.3 to V_{DD} + 0.3	V
Maximum output voltage	V_{OUT} max	V_{SS} – 0.3 to V_{DD} + 0.3	V
Allowable power dissipation	Pd max	500	mW
Operating temperature	Topr	–30 to +85	°C
Storage temperature	Tstg	–40 + 125	°C

Allowable Operating Ranges at Ta = 25°C, V_{SS} = 0 V

Parameter	Symbol	Conditions		min	typ	max	Unit
Supply voltage	V_{DD}	$V_{DD}1$, $V_{DD}2$, $V_{DD}3$		4.5		5.5	V
Input high level voltage	V_{IH} (1)	$\overline{RESET}$		0.7 V_{DD}		V_{DD}	V
	V_{IH} (2)	SFSY, PW, SBSY, MUTE, TEST, TEST1, TEST2, SON, M1/M2, N/P1, N/P2, PALID, $\overline{HRESET}$, $\overline{VRESET}$, 1DB0 to 3, 2DB0 to 3		2.2		V_{DD}	V
	V_{IH} (3)	CH0 to 15, DEN, CL, CE, DI		0.8 V_{DD}		V_{DD}	V
	V_{IH} (4)	S		0.9 V_{DD}		V_{DD}	V
Input low level voltage	V_{IL} (1)	$\overline{RESET}$		V_{SS}		0.3 V_{DD}	V
	V_{IL} (2)	SFSY, PW, SBSY, MUTE, TEST, TEST1, TEST2, SON, M1/M2, N/P1, N/P2, PALID, $\overline{HRESET}$, $\overline{VRESET}$, 1DB0 to 3, 2DB0 to 3		V_{SS}		0.8	V
	V_{IL} (3)	CH0 to 15, DEN, CL, CE, DI		V_{SS}		0.2 V_{DD}	V
	V_{IL} (4)	S		V_{SS}		0.1 V_{DD}	V
Input middle level voltage	V_{IM}	S		0.37 V_{DD}		0.43 V_{DD}	V
Data setup time	t_{DS}	DI, CL: Figure 1		200			ns
Data hold time	t_{DH}	DI, CL: Figure 1		200			ns
High level clock pulse width	t_{WaH}	CL: Figure 1		400			ns
Low level clock pulse width	t_{WaL}	CL: Figure 1		400			ns
DO setup time	t_{DOS}	DO, CL: Figure 1		250		450	ns
Input frequency	fin (1)	XIN1			14.31818		MHz
	fin (2)	XIN2			17.734476		MHz
		4FSC2	NTSC mode		14.31818		MHz
			PAL mode		17.734476		MHz
		FSCIN	NTSC mode		3.58		MHz
			PAL mode		4.43		MHz
CE wait time	t_{CP}	CE, CL: Figure 1		400			ns
CE setup time	t_{CS}	CE, CL: Figure 1		0			ns
CE hold time	t_{CH}	CE, CL: Figure 1		400			ns
Input amplitude	V_{IN}	XIN1, XIN2, 4FSC2, FSCIN: Sine wave, capacitive coupling		0.3		5	Vp-p
Reset pulse width	t_{WRES}	$\overline{RESET}$		400			ns

Electrical Characteristics at Ta = 25°C, V_{SS} = 0 V, V_{DD} = 5 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Current drain	I_{DD} (1)	$V_{DD}1$		26	40	mA
	I_{DD} (2)	$V_{DD}2$		26	40	mA
	I_{DD} (3)	$V_{DD}3$		11	15	mA
Input high level current	I_{IH} (1)	$\overline{RESET}$, SFSY, PW, SBSY, CE, DI, CL, MUTE, TEST, TEST1, TEST2, SON, M1/M2, N/P1, N/P2, $\overline{VRESET}$, $\overline{HRESET}$: V_{IN} = V_{DD}			5	μA
	I_{IH} (2)	CH0 to 15, DEN: V_{IN} = V_{DD}	30	100	200	μA

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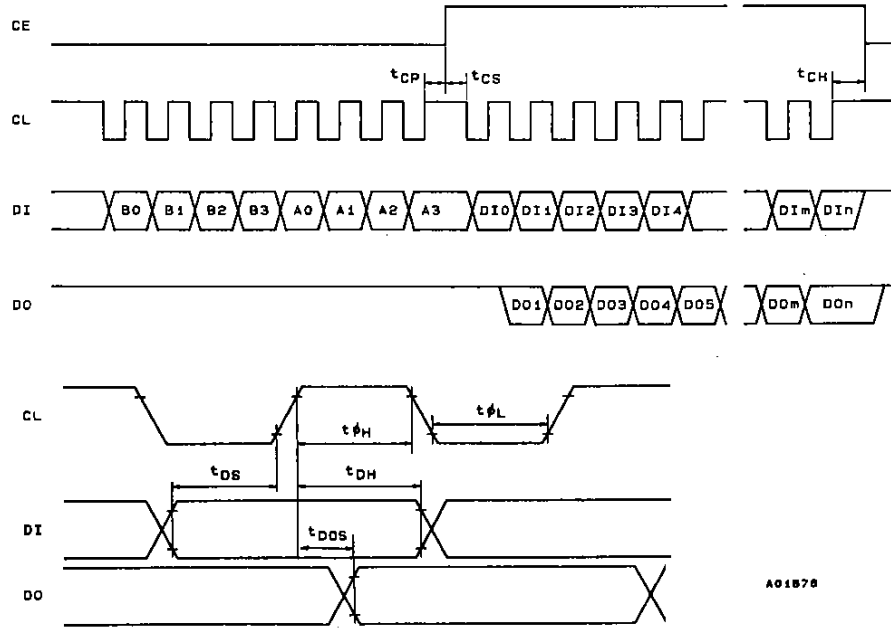| Parameter	Symbol	Conditions	min	typ	max	Unit
Input low level current	I_{IL} (1)	$\overline{RESET}$, SFSY, PW, SBSY, CE, DI, CL, MUTE, TEST, TEST1, TEST2, SON, M1/M2, N/P1, N/P2, $\overline{VRESET}$, $\overline{HRESET}$: $V_{IN} = V_{SS}$	−5			μA
	I_{IL} (2)	PALID: $V_{IN} = V_{SS}$	−400	−200	−60	μA
Output high level voltage	V_{OH} (1)	SBCK, $\overline{1WE}$, $\overline{RAS}$, 1A0 to 7, 2A0 to 7, $\overline{CAS}$, $\overline{OE}$, $\overline{2WE}$, CDGM, TRANS0 to 5, 2FSC, YS, $\overline{CSYNC}$, VSYNC, EFLG, FSX, FSC, 1DB0 to 3, 2DB0 to 3: I_O = −0.5 mA	$V_{DD} - 1$		V_{DD}	V
Output low level voltage	V_{OL} (1)	SBCK, $\overline{1WE}$, $\overline{RAS}$, 1A0 to 7, 2A0 to 7, $\overline{CAS}$, $\overline{OE}$, $\overline{2WE}$, CDGM, TRANS0 to 5, 2FSC, YS, $\overline{CSYNC}$, VSYNC, EFLG, FSX, FSC, 1DB0 to 3, 2DB0 to 3: I_O = 2 mA	V_{SS}		0.4	V
	V_{OL} (2)	DO: I_O = 5 mA	V_{SS}		0.75	V
Output off leakage current	I_{OFF}	DO, 1DB0 to 3, 2DB0 to 3	−5		+5	μA
Built-in feedback resistance	RX	XIN1, XIN2, 4FSC2, FSCIN		1		MΩ
6-bit D/A converter reference voltage	V_{REF} (1)	ROUT, BOUT, GOUT, TRANS	3.95	4	4.05	V
6-bit D/A converter output resistance	R_{DA} (1)	ROUT, BOUT, GOUT, TRANS		150		Ω
8-bit D/A converter reference voltage	V_{REF} (2)	VIDEO	3.65	3.70	3.75	V
8-bit D/A converter output resistance	R_{DA} (2)	VIDEO		150		Ω
8-bit D/A converter output level	VDAC	VIDEO: Figure 9				
Random read/write cycle time	t_{RC}	Figures 2 and 3	400			ns
Page mode cycle time	t_{PC}	Figures 4 and 5	130			ns
$\overline{RAS}$ precharge time	t_{RP}	Figures 2, 3, 4, 5 and 6	100			ns
$\overline{RAS}$ pulse width	t_{RAS}	Figures 2, 3 and 6	120			ns
$\overline{RAS}$ pulse width (page mode)	t_{RASP}	Figures 4 and 5			18000	ns
$\overline{RAS}$ hold time	t_{RSH}	Figures 2, 3, 4 and 5	60			ns
$\overline{CAS}$ hold time	t_{CSH}	Figures 2 and 3	120			ns
$\overline{CAS}$ pulse width	t_{CAS}	Figures 2, 3, 4 and 5	60			ns
$\overline{CAS}$ precharge time	t_{CPN}	Figure 6	50			ns
$\overline{CAS}$ precharge time (page mode)	t_{CP}	Figures 4 and 5	50			ns
Row address setup time	t_{ASR}	Figures 2, 3, 4 and 5	100			ns
Row address hold time	t_{RAH}	Figures 2, 3, 4 and 5	50			ns
Column address setup time	t_{ASC}	Figures 2, 3, 4 and 5	0			ns
Column address hold time	t_{CAH}	Figures 2, 3, 4 and 5	50			ns
Read command setup time	t_{RCS}	Figure 2	150			ns
Read command hold time (referenced to $\overline{CAS}$)	t_{RCH}	Figure 2	120			ns
Read command hold time (referenced to $\overline{RAS}$)	t_{RRH}	Figure 2	120			ns
Write command setup time	t_{WCS}	Figure 3	100			ns
Write command hold time	t_{WCH}	Figure 3	50			ns
Write command pulse width	t_{WP}	Figure 3	150			ns
Write data setup time	t_{DS}	Figure 3	100			ns
Write data hold time	t_{DH}	Figure 3	100			ns
$\overline{CAS}$ setup time ($\overline{CAS}$ before $\overline{RAS}$)	t_{CSR}	Figure 6	50			ns
$\overline{CAS}$ hold time ($\overline{CAS}$ before $\overline{RAS}$)	t_{CHR}	Figure 6	50			ns
$\overline{RAS}$ precharge · $\overline{CAS}$ active time	t_{RPC}	Figure 6	50			ns
Read data setup time	t_{RDS}	Figures 2, 4 and 5	20			ns
Read data hold time	t_{RDH}	Figures 2, 4 and 5	10			ns
VIDEO setup time	t_{VS}	Superimposition: Figure 7	20		25	ns
SBCK output delay time	t_{SD}	Figure 8 — NTSC mode	4.749		5.029	μs
		Figure 8 — PAL mode	4.793		5.075	μs
SBCK cycle frequency	f_{SC}	Figure 8 — NTSC mode		223.7		kHz
		Figure 8 — PAL mode		221.7		kHz
PW setup time	t_{PWS}	Figure 8	100			ns

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Figure 1   Microcontroller Interface Timing
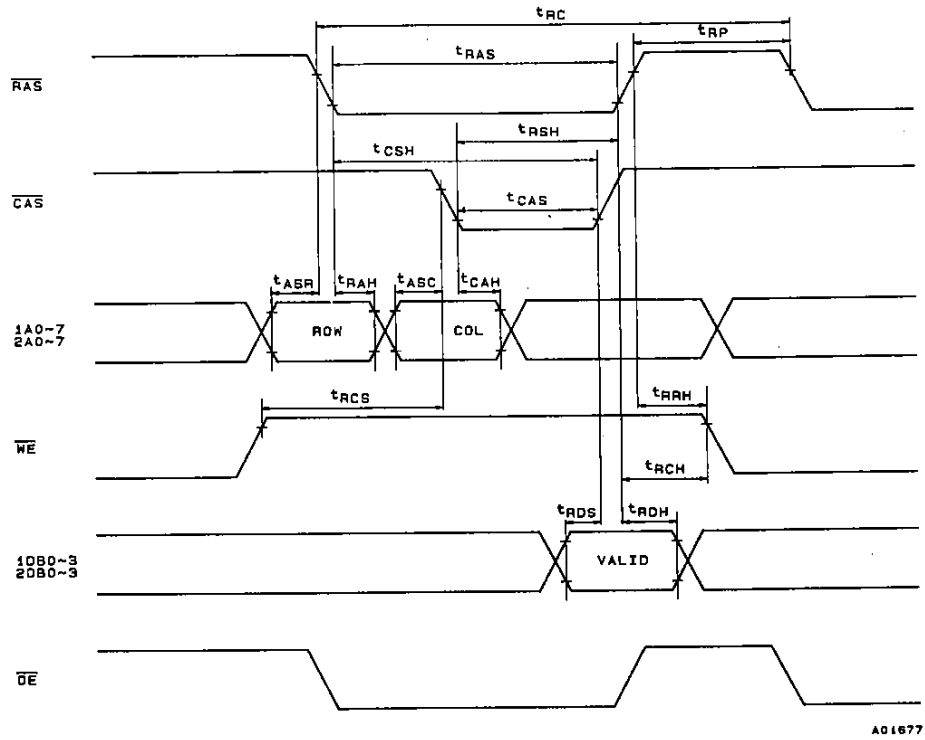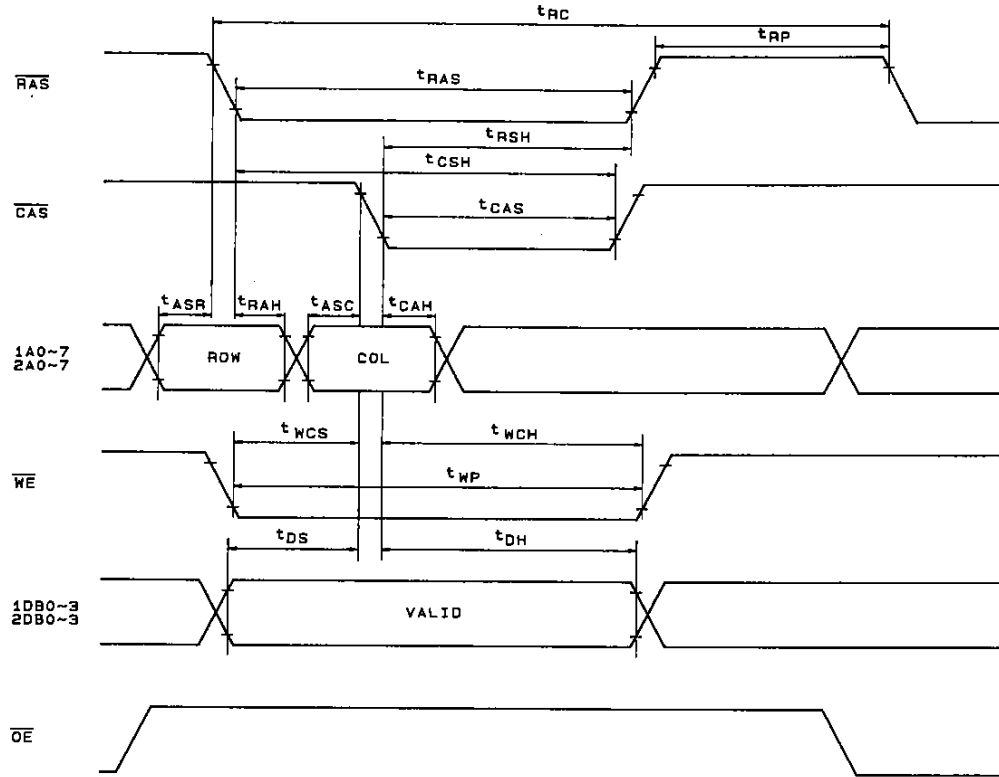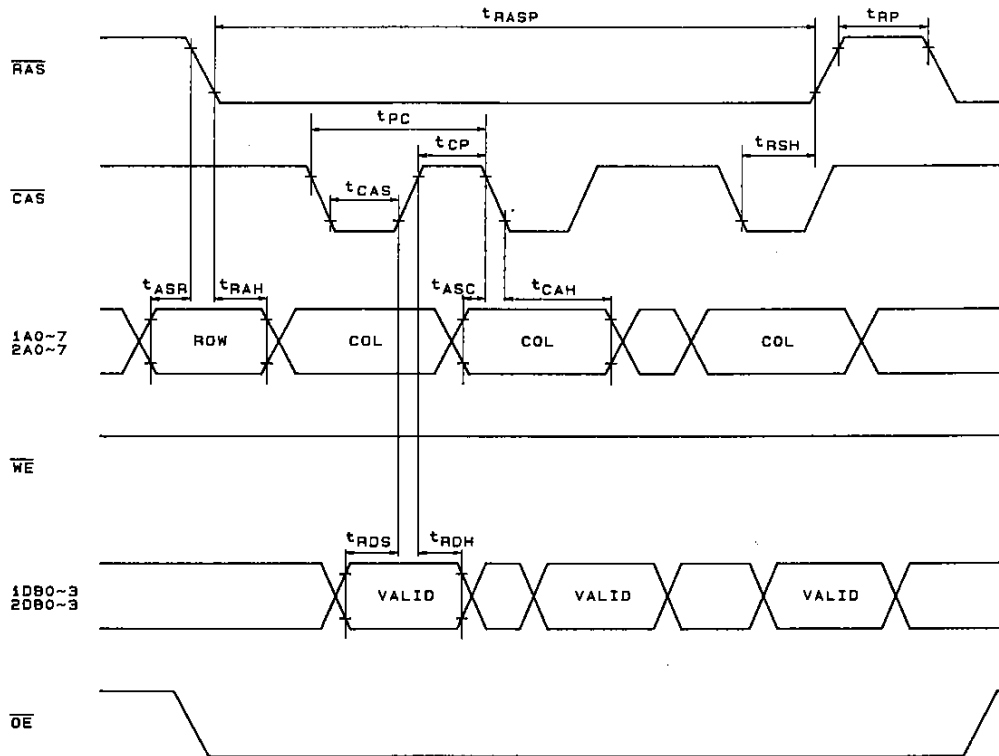

Figure 2   DRAM Read Cycle

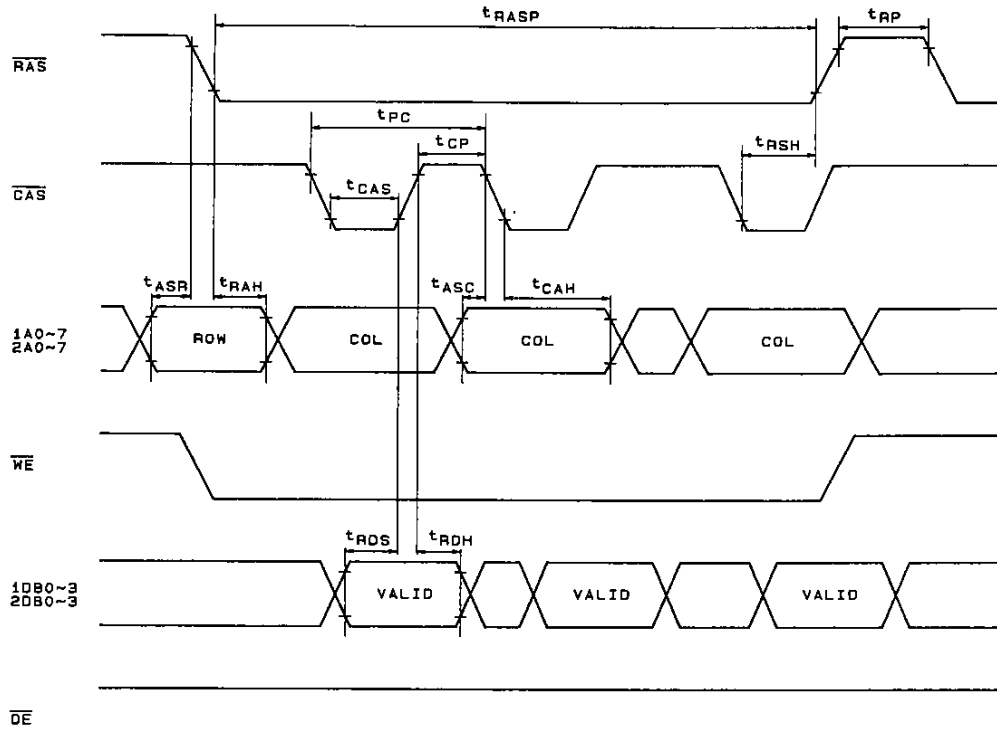Figure 3   DRAM Early Write Cycle

Figure 4   DRAM Page Mode Read Cycle
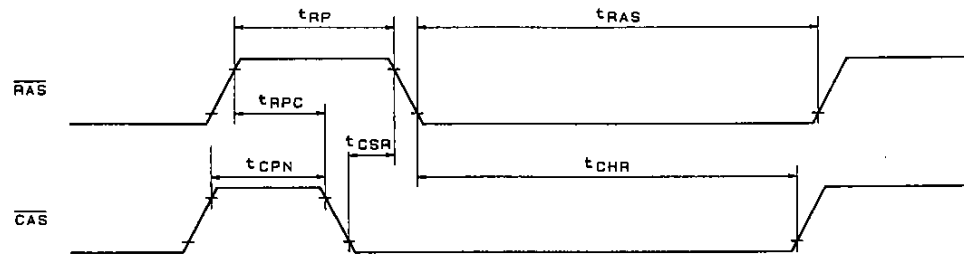
Figure 5   DRAM Page Mode Write Cycle

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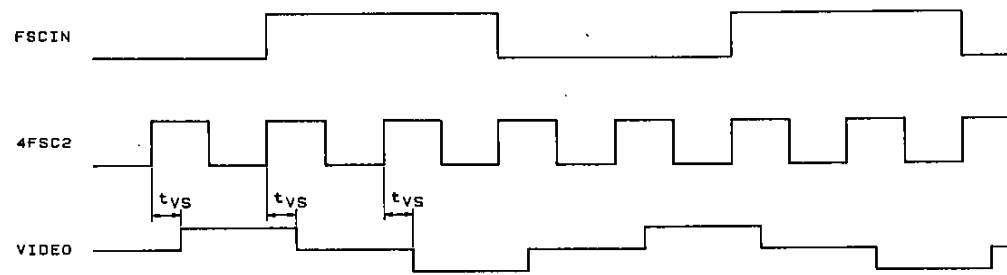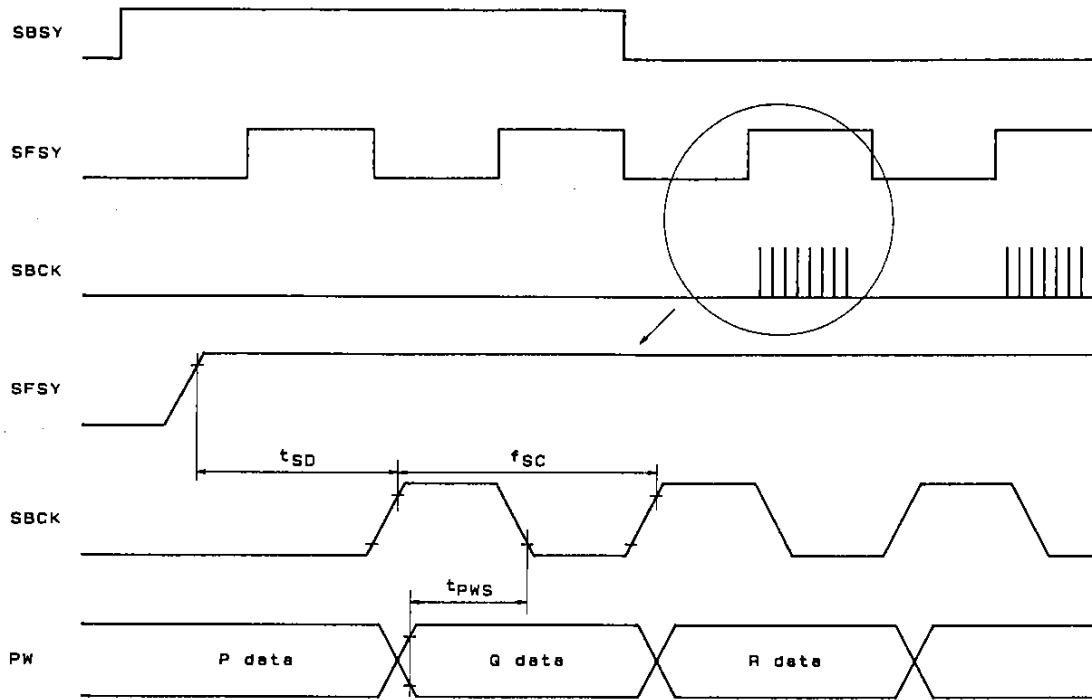Figure 6   DRAM $\overline{CAS}$ before $\overline{RAS}$ Refresh Cycle

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Figure 7   Phase Relationships in Superimposition Mode
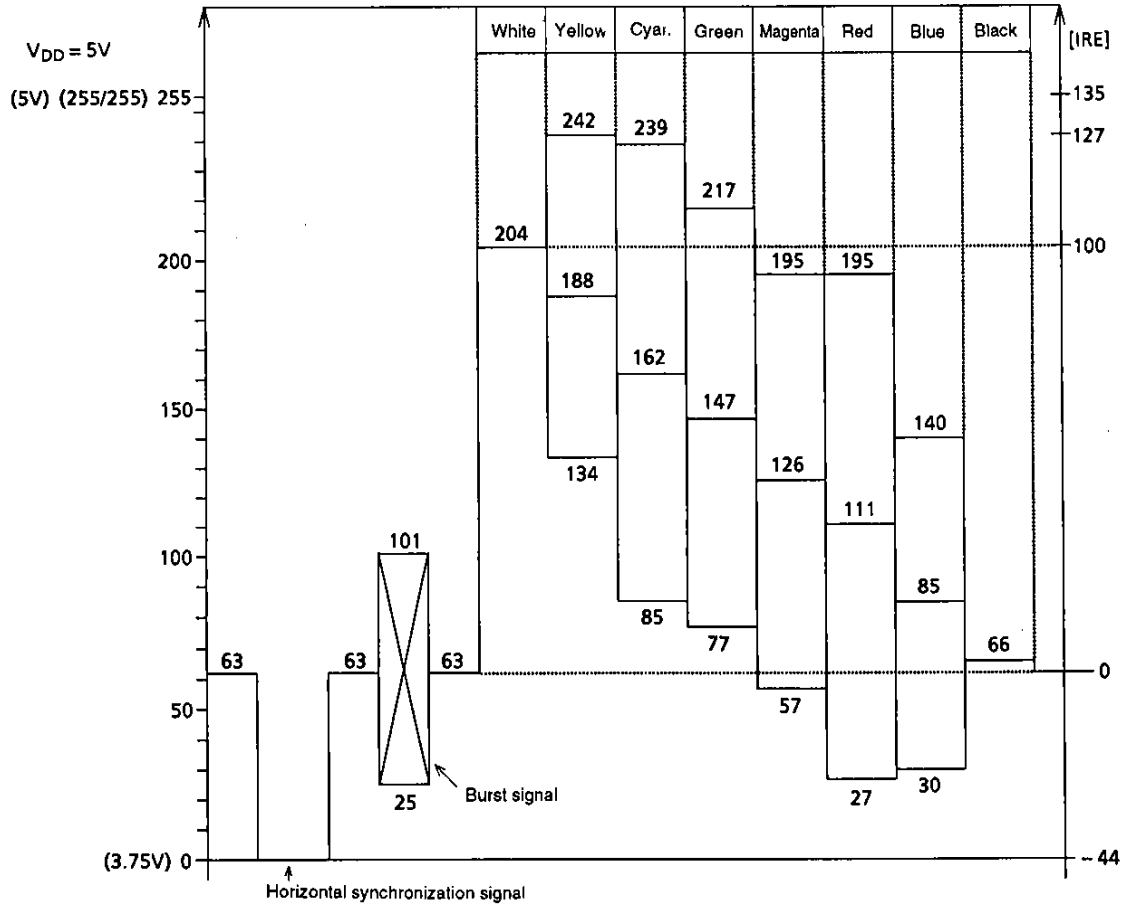
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S pin low

Figure 8   Subcode Interface

Figure 9   Composite Video Signal Output (8 bits)

Pin Functions

Pin No.	Pin	I/O	Function
1	S	I	CD DSP selection: High level input: LC7861N/67, middle level input: LC7860K/63, low level input: LC7868/69
2	SBCK	O	P to W subcode read clock
3	SFSY	I	Subcode frame synchronization signal
4	PW	I	P to W subcode data
5	SBSY	I	Subcode block synchronization signal
6	$V_{DD}1$	—	Digital system power supply
7	CE	I	Control during serial input or serial output
8	DO	O	Serial data output
9	DI	I	Serial data input
10	CL	I	Serial data I/O clock
11	MUTE	I	Control signal used to specify that the subcode data be handled as invalid
12	$V_{SS}1$	—	Digital system ground
13	CH0	I	
14	CH1	I	
15	CH2	I	
16	CH3	I	
17	CH4	I	
18	CH5	I	
19	CH6	I	
20	CH7	I	Channel selection pins. A high level enables the corresponding channel.
21	CH8	I	These pins have built-in pull-down resistors.
22	CH9	I	
23	CH10	I	
24	CH11	I	
25	CH12	I	
26	CH13	I	
27	CH14	I	
28	CH15	I	
29	$\overline{1WE}$	O	Primary DRAM control
30	$\overline{RAS}$	O	Control pin shared by primary and secondary DRAM
31	1A0	O	
32	1A1	O	
33	1A2	O	
34	1A3	O	
35	1A4	O	Primary DRAM address
36	1A5	O	
37	1A6	O	
38	1A7	O	
39	1DB0	I/O	Primary DRAM data
40	$\overline{CAS}$	O	Control pin shared by primary and secondary DRAM
41	1DB1	I/O	Primary DRAM data
42	$\overline{OE}$	O	Control pin shared by primary and secondary DRAM
43	1DB2	I/O	Primary DRAM data
44	1DB3	I/O	
45	$\overline{2WE}$	O	Secondary DRAM control
46	2A0	O	
47	2A1	O	
48	2A2	O	
49	2A3	O	Secondary DRAM address
50	2A4	O	
51	2A5	O	
52	2A6	O	
53	2A7	O	

LC7871E, 7871NE

Pin No.	Pin	I/O	Function
54	2DB0	I/O	
55	2DB1	I/O	
56	2DB2	I/O	Secondary DRAM data
57	2DB3	I/O	
58	TEST	I	IC testing
59	CDGM	O	Outputs a high level when reading a CD-G disk
60	TRANS0	O	
61	TRANS1	O	
62	TRANS2	O	
63	TRANS3	O	Transparency digital output
64	TRANS4	O	
65	TRANS5	O	
66	$V_{SS}2$	—	Analog system ground
67	$V_{DD}2$	—	Analog system power supply
68	BIAS1	O	Ripple rejection capacitor connection
69	TRANS	O	Define-transparency 6-bit D/A converter output
70	ROUT	O	Red data 6-bit D/A converter output
71	GOUT	O	Green data 6-bit D/A converter output
72	BOUT	O	Blue data 6-bit D/A converter output
73	$V_{SS}3$	—	Analog system ground
74	$V_{DD}3$	—	Analog system power supply
75	BIAS2	O	Ripple rejection capacitor connection
76	VIDEO	O	Composite video output (8-bit D/A converter output)
77	TEST1	I	IC testing
78	TEST2	I	
79	FSCIN	I	Subcarrier clock input (feedback resistor built in)
80	VSYNC	O	Vertical synchronization signal output
81	2FSC	O	2FSC output
82	YS	O	Superimposition control output
83	$\overline{CSYNC}$	O	Composite sync output
84	SON	I	Superimposition on/off
85	EFLG	O	Error state monitor
86	FSX	O	Error state monitor trigger
87	M1/M2	I	Selects one or two 256 kbit DRAMs: High: one DRAM, low: two DRAMs
88	DEN	I	Disk information display enable: High: BGC, low: enable (pull-down resistor built in)
89	PALID	I	PAL mode superimposition control (pull-up resistor built in)
90	$\overline{HRESET}$	I	External horizontal timing control
91	FSC	O	Subcarrier clock output NTSC mode: 3.579545 MHz, PAL mode: 4.433619 MHz
92	$\overline{VRESET}$	I	External vertical timing control
93	4FSC2	I	External superimposition mode clock input (feedback resistor built in)
94	$\overline{RESET}$	I	Reset input
95	N/P1	I	NTSC/PAL selection: High: NTSC, low: PAL (RGB encoder)
96	N/P2	I	NTSC/PAL selection: High: NTSC, low: PAL (CD-G decoder)
97	XIN2	I	Crystal oscillator connection 17.734476 MHz (PAL)
98	XOUT2	O	
99	XIN1	I	Crystal oscillator connection 14.31818 MHz (NTSC)
100	XOUT1	O	

CD-EG Instructions

Of the instructions in the R to W subcode described in the CD Red Book, the LC7871E and the LC7871NE support the following:

1. MODE = 0, ITEM = 0: ZERO mode

2. MODE = 1, ITEM = 0: LINE GRAPHICS mode
    • Write FONT instruction (4)
    • Write Scroll SCREEN instruction (12)

3. MODE = 1, ITEM = 1: TV-GRAPHICS mode
    • Preset MEMORY instruction (1)
    • Preset BORDER instruction (2)
    • Write FONT FOREGROUND/BACKGROUND instruction (6)
    • Scroll SCREEN with preset instruction (20)
    • Scroll SCREEN with Copy instruction (24)
    • Load CLUT color-0...7 instruction (30)
    • Load CLUT color-8...15 instruction (31)
    • EXCLUSIVE-OR FONT instruction (38)
    • Define color Transparency instruction (28)

4. MODE = 1, ITEM = 1 & 2: EXTENDED TV-GRAPHICS mode
    • MEMORY Control instruction (3)
    • Write additional FONT FOREGROUND/BACKGROUND instruction (6)
    • EXCLUSIVE-OR additional FONT with 2 colors instruction (14)
    • Load CLUT color instruction (16-47)
    • Load CLUT additional color instruction (48-63)

Pin Applications

1. Crystal Clock Oscillator: Pins XIN1, XOUT1, XIN2, XOUT2, N/P1, N/P2, FSC, CSYNC, 2FSC and VSYNC

    The XIN1 and XOUT1 pins are for use with a 14.31818 MHz (NTSC) crystal oscillator. The XIN2 and XOUT2 pins are for use with a 17.734476 MHz (PAL) crystal oscillator. The LC7871E and LC7871NE provide the above two crystal oscillator systems. Depending on the application, either a single crystal can be connected, or alternatively two crystals can be used allowing control from both the N/P1 and the N/P2 pins. The N/P1 pin switches the RGB encoder block between PAL and NTSC and the N/P2 pin switches the CD-G decoder block between PAL and NTSC. The FSC and 2FSC pins output the crystal oscillator frequency divided by 4 and 2 (2/5 in PAL mode) respectively. The CSYNC pin outputs a composite sync signal, and the VSYNC pin outputs a vertical sync signal.

    The table below shows the pin outputs in the various modes.

XIN1, XOUT1	XIN2, XOUT2	N/P1	N/P2	TV Standard	FSC	2FSC	CSYNC
14.31818 MHz	*	H	H	NTSC/M	3.579545 MHz	7.15909 MHz	16.65155767 ms
*	17.734476 MHz	L	L	PAL/GBIDH	4.433619 MHz	7.093790 MHz	20.09588555 ms
14.30244 MHz	*	L	H	PAL/M	3.575611 MHz	7.15122 MHz	16.6698829 ms
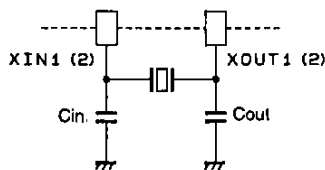
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Recommended Crystal Oscillator Constants

	Manufacturer	Oscillator	Cin/Cout
NTSC	CITIZEN WATCH CO., LTD	CSA-309 (14.31818 MHZ)	5 to 8 pF (Cin = Cout)
PAL	CITIZEN WATCH CO., LTD	CSA-309 (17.734475 MHZ)	5 to 12 pF (Cin = Cout)

2. Subcode Interface: Pins S, SBSY, SFSY, PW, SBCK and MUTE

The S pin selects one of three interface modes, as shown in the table below. When a high level is applied to the MUTE pin, SBSY and PW input are disabled, and SBCK output is disabled.

S	H	M	L
Mode	LC7861N/67 interface	LC7860K/63 interface	LC7868/69 interface

Note that the "M" level is typically 0.4 V_{DD}.

- LC7860 interface (Symbols in parentheses are LC7860 pins.)

The conditions for SBCK output are as follows: confirmation of low levels on the SFSY pin about 2.2 μs after a falling edge on SFSY.
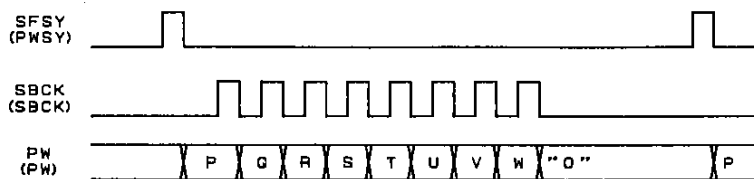

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Note: * SFSY will be high during the S0 and S1 periods.
   * The SBSY pin must be held low.

- LC7861N/67 interface (Symbols in parentheses are DSP pins.)

The conditions for SBCK output are as follows: confirmation of a low level on the SBSY pin about 2.2 μs after a falling edge on the SFSY pin in the LC7871E.

In the LC7871NE the conditions are confirmation of a low level on the SBSY pin about 2.2 μs after a rising edge on the SFSY pin.
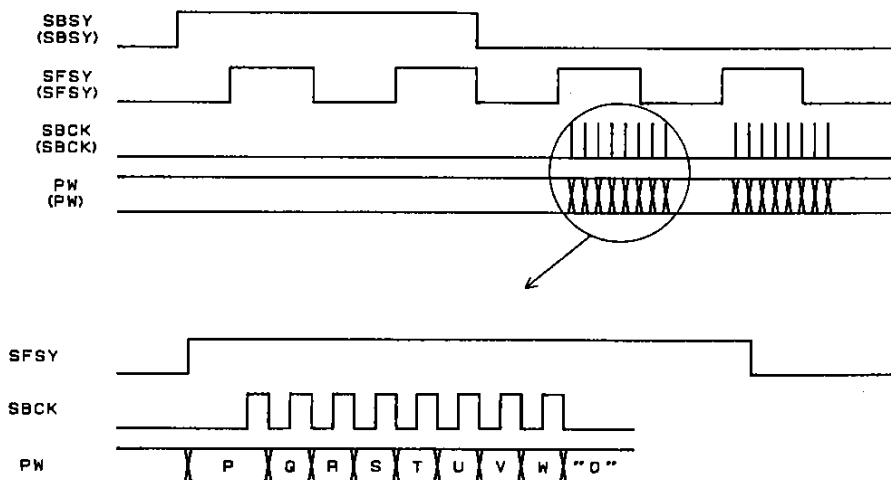
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• LC7868/69 interface

This interface is identical to that described in item 2 above, except that the SBCK polarity is reversed, i.e., the shift occurs on a rising edge.

3. DRAM Interface: Pins 1A0 to 1A7, 1DB0 to 1DB3, $\overline{RAS}$, $\overline{CAS}$, $\overline{1WE}$, $\overline{OE}$, 2A0 to 2A7, 2DB0 to 2DB3, $2\overline{WE}$ and M1/M2

The LC7871E and LC7871NE use external 64k by 4-bit DRAMs.

Two external DRAMs are required for CD-EG. Only one external DRAM is required for CD-G. The M1/M2 pin setting must match the number of DRAMs actually used. When single memory chip operation is selected by setting the M1/M2 pin high, the pins 2DB0 to 3 function in output mode. Thus the pins 2A0 to 7, 2DB0 to 3, $2\overline{WE}$ and $2\overline{OE}$ can be left open.

4. Display Format: Pins DEN, N/P1, N/P2, CSYNC, $\overline{VRESET}$, $\overline{HRESET}$, YS, VIDEO, PALID, TRANS and TRANS0 to TRANS5

• Data which has undergone error detection and correction is encoded by the built-in RGB encoder, converted to analog by the 8-bit D/A converter, and output from the VIDEO pin. This system can handle both PAL and NTSC modes, and either mode can be specified from the N/P pin. See item 1 for the states of the pins in the PAL and NTSC modes.

• The YS, $\overline{VRESET}$, $\overline{HRESET}$, PALID, TRANS and TRANS0 to TRANS5 pins are used in superimposition processing.

• The DEN pin is a display control pin. When this pin is at a low level, the internal font data is output, and when at a high level, the color data loaded into the registers is output. The default state is blue.
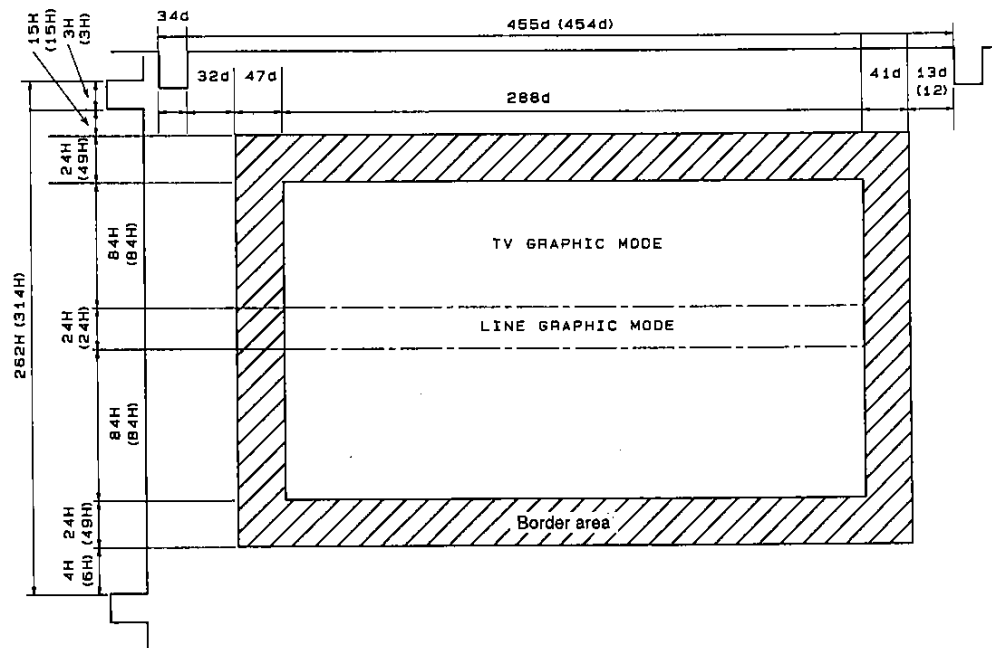
A01686

5. Channel Selection: Pins CH0 to CH15

The channel can be selected by controlling the values of the CH0 to CH15 pin input values. The logical OR is taken with the microprocessor input register.

6. CD Graphics Monitor: The CDGM pin

The CDGM signal goes high when the LC7871E or LC7871NE receives, even once, any one of the page 11 CDG instructions. Since the circuits are connected as soon as this signal goes high in the power on state, a reset will be required when changing disks if this pin is used.

7. Video Output: The VIDEO pin

A composite video signal can be acquired from the VIDEO pin. The output level from the 8-bit D/A converter is 1.25 Vp-p. Therefore, an external 6 dB video amplifier is required to acquire a 1 Vp-p rated output.
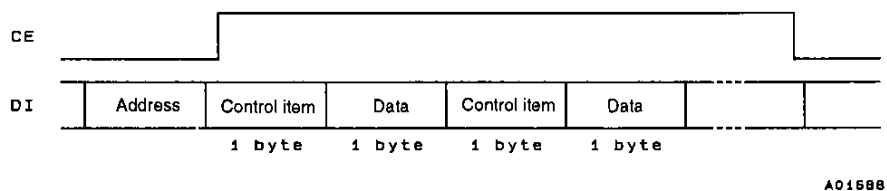
8. Error Flag Output: Pin EFLG and FSX

The error detection result can be monitored from the EFLG pin.

The Q parity result can be monitored during the FSX high level period.

A01587
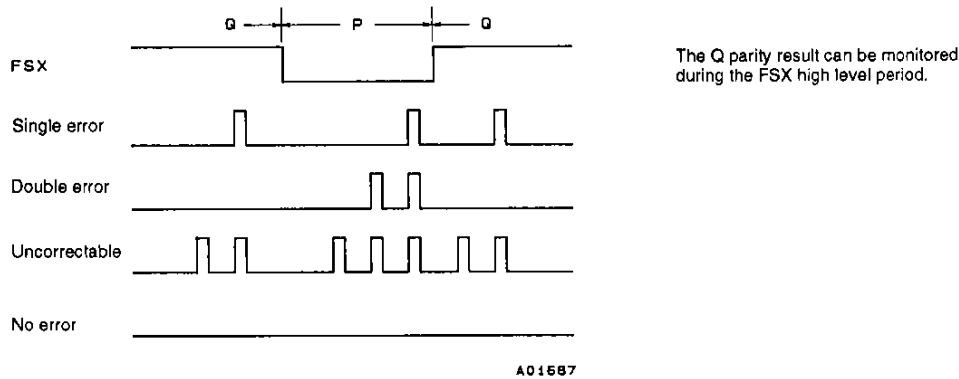
Microcontroller Interface (C²B bus)

1. 2N byte command input

A01588

Address (F4h): lsb [00101111] msb
Control item: lsb [0---AAAA] msb   A = register number

Register 0 (mode setting)
  Data: lsb [ABCDEFGH] msb.   The default is [00000110].
      A = VRAM/BG   0: Display the contents of VRAM
                      1: Display the background color
      B = TV/LINE   0: TV mode (Extended TV mode)
                      1: Line graphics mode
      C = Disk command enable
                      0: Disk commands are accepted. MGC commands (microcontroller graphics commands, executed by 19-byte command inputs) are executed between disk commands.
                      1: Disk commands are ignored and only MGC commands are executed.

D = Command select

      0: Normal operation

      1: Register 9 is used for VRAM display control (PM or SM) and MGC access memory control.

EFG = Comparison conditions for superimposition mode (only valid when SON = 1)

    EF = 00: No comparison performed.

          01: When the border color is not black, YS is set high (display) for portions that do not match the border color, and is set low (clear) otherwise.

          11: YS is set high for sections that do not match the chroma key color, and is set low otherwise.

      G = 0: When EF is 00 or the comparison condition is false for EF = 01, the whole screen is set low (clear).

      G = 1: When EF is 00 or the comparison condition is false for EF = 01, the whole screen is set high (display).

H = INIT

      0: Normal operation

      1: Internal reset

    On an internal reset the display screen is reset to the BGC screen.

Register 1 (screen position adjustment)

    Data: lsb [HHHHVVVV] msb.   The default is [00000000].

    H = Horizontal direction. Specified as a two's complement value with positive values indicating a shift to the left. The position can be shifted from –16 to +14 dots from the center in two dot increments.

    V = Vertical direction. Specified as a two's complement value with positive values indicating an upwards shift. The position can be shifted from –16 to +14 dots from the center in two dot increments.

Register 2 (on/off control of channels 0 through 7)

    Data: lsb [CCCCCCCC] msb.   The default is [00000000].

    C = CH0 to CH7. 0: off, 1: on

    Channels 0 through 7 are controlled according to the logical OR of this register and the CH0 to CH7 input pins.

Register 3 (on/off control of channels 8 through 15)

    Data: lsb [CCCCCCCC] msb.   The default is [00000000].

    C = CH8 to CH15. 0: off, 1: on

    Channels 8 through 15 are controlled according to the logical OR of this register and the CH8 to CH15 input pins.

Register 4 (BGC R and G setting)

    Data: lsb [RRRRGGGG] msb.   The default is [00000000].

Register 5 (BGC B setting)

    Data: lsb [----BBBB] msb.   The default is [----0101].

Register 6 (chroma key color setting, R)

    Data: lsb [--RRRRRR] msb.   The default is [--010000].

Register 7 (chroma key color setting, G)

    Data: lsb [--GGGGGG] msb.   The default is [--010000].

Register 8 (chroma key color setting, B)

    Data: lsb [--BBBBBB] msb.   The default is [--010000].

Register 9 (VRAM display and control switching)

Data: lsb [----DDWW] msb.   The default is [----1001].

This register switches the display between the two VRAMs (primary memory and secondary memory) and also sets the MGC access. (Disk command access is limited to PM access.) Note that these settings are only valid when the register 0 command selection is set to 1 and VRAM is 512 kbytes. (The item 2 command will be ignored and 16-color display used.)

DD = Display memory control (01: display PM, 10: display SM, 11: additive mix)

WW = MGC access memory control (01: work PM, 10: work SM, 11: work PM & SM)

Register 10 (Software reset, external sync on/off, test mode)

Data: lsb [TTT--YSR] msb.   The default is [000--000].

T = Test mode setting

R = Software reset, 0: Normal operation, 1: Reset

The display screen will be held until the next command is executed when a software reset is performed.

S = 0: TRANS is initialized on a software reset.
    1: TRANS is not initialized on a software reset.

Y = 0: Reset on HRESET and VRESET in external clock mode (SON = 1).
    1: Reset on VRESET in external clock mode (SON = 1). (HRESET is unnecessary.)

Register 11 (subtitle vertical scrolling)

Data: lsb [---VVVVV] msb.   The default is [---00000].

The screen position can be scrolled vertically in units of the font height.

V = Vertical scroll distance (0 to 17 font heights.)

Register 12 (subtitle horizontal scrolling)

Data: lsb [--HHHHHH] msb.   The default is [--000000].

The screen position can be scrolled horizontally in units of the font width.

H = Horizontal scroll distance (0 to 49 font widths.)

Register 13 (TRANS setting, only valid when SON = 1)

Data: lsb [PSBBBBBB] msb.   The default is [11000000].

P = 1: Makes the PM TRANS setting valid. 0: Invalid (whole screen display)

S = 1: Makes the SM TRANS setting valid. 0: Invalid (whole screen display)

B = The BGC TRANS value

Register 14 (YS and TRANS output timing)

Data: lsb [----TTTT] msb.   The default value is [----0001].

T = The phase between the video signal and the YS and TRANS (digital output) signals in 70 ns units.

The value of T can be set to one of the ten values in the range 0 to 9. In NTSC mode, YS and TRANS will be in phase with the RGB output when T = 0, and with the C output when T = 8 or 9.

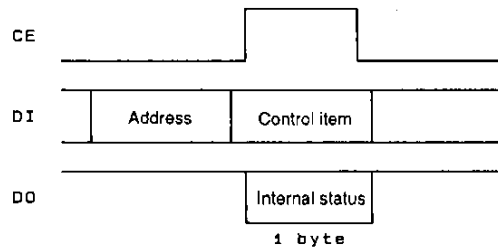2. 19-byte command input (MGC write)
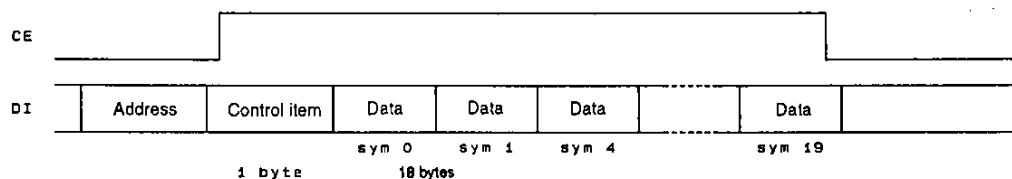
Address (F4h): lsb [00101111] msb

Control item: lsb [1-------] msb

Data: lsb [--WVUTSR] msb.   W to R are the subcode inputs.

Executed on the falling edge of the CE signal. Note that this operation cannot be executed during command execution or when TIMER is 10 or 11.

3. Single-byte command output (internal status readout)

A01590

Address (F5h): lsb [10101111] msb
Control item: lsb [0-------] msb
Data: lsb [-ABCTTTT] msb

    A = Read request bit. 1: The packed data has been updated. Read access will be possible within 1.1 ms has passed.
               0: Packed data read out prohibited state.

    B = Command execution in progress.
               1: Command execution in progress.
               0: Command wait state.

    C = VBLANK. Set to 1 during the vertical blanking period.

    T = Timer. Outputs the command cycle (3.30 ms) from the CD divided by 12.
               T = 0: 0.00 ms
                     1: 0.27 ms
                     2: 0.55 ms
                     :
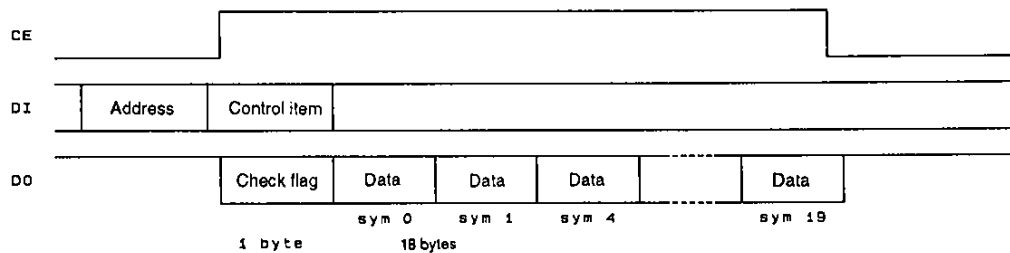   10: 2.75 ms
                 11: 3.02 ms (command issued from the CD)
                  0: 3.30 ms (0.00 ms)
                   When the register 0 C value is 0, MGC must be written in the interval when the timer is between 0 and 9 in the command wait state.

4. 19-byte command output (packed data readout)

A01591

Address (F5h): lsb [10101111] msb
Control item: lsb [1-------] msb
Check flag: lsb [-ABCQQPP] msb
Data: lsb [--WVUTSR] msb

        A is set to 1 when the following 18 bytes are guaranteed and furthermore, this is the first time that the data has been read out. (The readout must be completed within 1.1 ms.)

        B, C: Disk identification flags

                BC = 00: CD

                BC = 10: CD-G
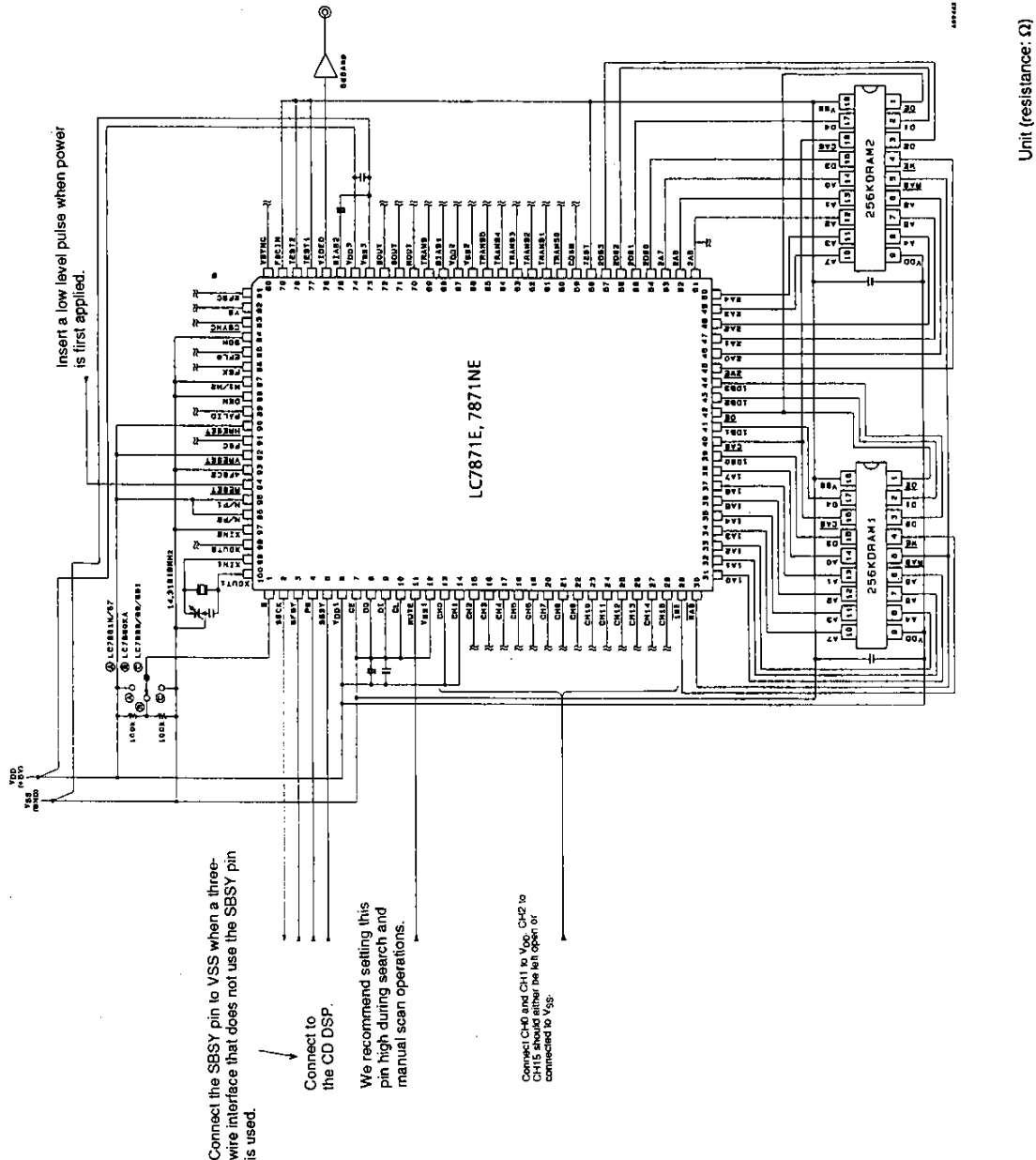
                BC = 11: CD-EG

        Q = QF0 and QF1 (error correction Q flags)

        P = PF0 and PF1 (error correction P flags)

Note that when it is not necessary to read out all 19 bytes, the read can be discontinued at any time in byte units.
Note that it is also possible to read out only the check flag.

LC7871E and LC7871NE CD-EG Application Circuit (NTSC)

Unit (resistance: Ω)

Insert a low level pulse when power is first applied.

Connect the SBSY pin to VSS when a three-wire interface that does not use the SBSY pin is used.

Connect to the CD DSP.

We recommend setting this pin high during search and manual scan operations.

Connect CH0 and CH1 to Vᴅᴅ. CH2 to CH15 should either be left open or connected to Vꜱꜱ.

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